UCKI CM ELECTRON	IICS Co.,Ltd		ROHS
	APPROVAL SHE	ΞT	
Customer :			
Part Number:	TUNING FORK CI	RYSTAL	
LK Part No.:	L383DK32M21L	(\mathbf{O})	
Holder :	DT-38		
Frequency:	32.768KHz 12.5P	F ±20PPM	
Manufacturer:	Lucki Electronics		
Date:	2023-04-27		
Prepared	Checked	Approved	
Zhao Qian	Zhang Dongwei	Zhang Bin	
(For Custome			
Accepta			



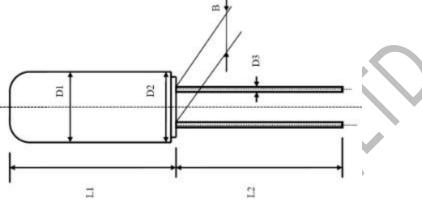
1. ELECTRICAL SPECIFICATIONS

1.1 Hold Type: DT308

Parameter	Symb	Value	Condition
Frequency Range	Fo	32.768Khz	
Frequency Tolerance	$\Delta f/fo$	±20PPM	REF TO 25°C
Temperature Coefficient	K	-0.034±0.006 ppm/(°C) ²	
Turnover Temperature	T _{TO}	25±5℃	
Operating Temperature Range	Тор	-20°C to 70°C	
Storage emp rature Range	T _{ST}	-40℃ to 85℃	
Quality Factor	Q	60,000TYP	
Series Resistance	R ₁	30 K Ω	K Ω Max REF TO 25°C
Shunt Capacitance	Со	1.8 PF TYP	0.9~2.0PF
Motional Capacitance	C1	2.1 Ff TYP	4 Ff Max
Load Capacitance	CL	12.5 PF	
Insulator Resistance	IR	500 M Ω	DC100V±15V
Drive Level	DL	1 ц W	Max
Capacitance ratio	R	450TYP	

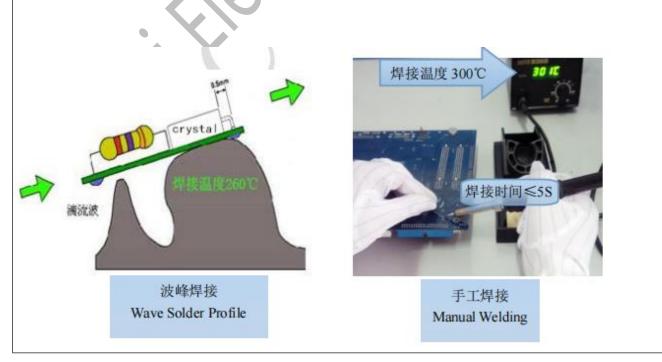


1.2 Dimension (Unit: mm)



				5		
型号/尺寸	L1	L2	D1	D2	D3	В
3*8	8.3Max	9.0Min	2.95±0.1	3.0 ± 0.1	0.3 ± 0.05	0.8 ± 0.05

1.3 The soldering requirements





2. TEST STANDARD

2.1 GENERAL ELECTRICAL CHARACTERISTICS AND VISUALTESTING

2.1.1 LOT CLASSIFICATION : If the quantity is 1000 PCS or more, 1000 PCS is one lot

2.1.2 SAMPLING TEST METHOD : MIL-STD-105E G-II

2.1.3 TEST LEVEL

A) HIGH LEVEL DEFECT : AQL 0.065% [200 pcs]

B) MEDIUM LEVEL DEFECT : AQL 0.25% [50 pcs]

C) LOW LEVEL DEFECT :AQL0.4% [32 pcs]

2.1.4 DEFECT CLASSIFICATION

A) HIGH LEVEL

@NO FREQUENCY

@MIXING

@LEAK DEFECT

B) MEDIUM LEVEL - ELECTRICAL CHARACTERISTIC DEFECT

@FREQUENCY

@OSCILLATION

@ELECTRICAL CURRENT

@OTHER ELECTRICAL CHARACTERISTICS DEFECT

C) VISUAL

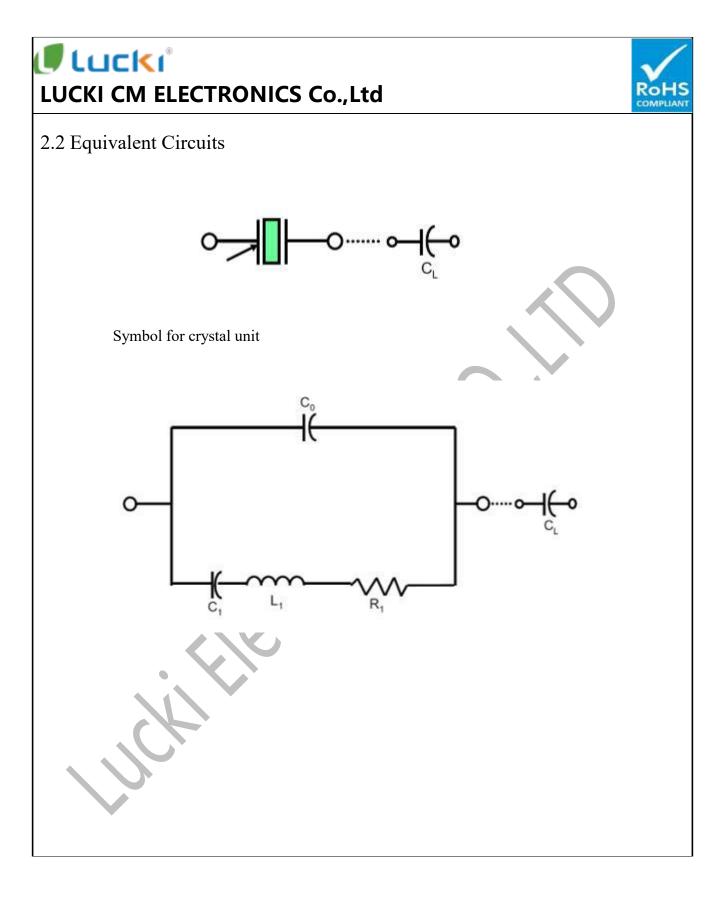
@MARKING

@WELDING

@LEADS

@OTHER VISUAL DEFECT

TESTING METHOD AND ITS STANDARD CAN BE MODIFIED DEPENDING ON THE CUSTOMER'S REQUEST





3.RELIABILITY (MECHANICAL AND ENVIRONMENTAL ENDURANCE)

		ENDURANCE)	
NO.	TEST	TEST METHOD AND CONDITION	REQUIREMENTS
1	VIBRATION	(3)CYCLE TIME: 1~2MIN(10-55-10HZ)	FREQUENCY CHANGE: ± 10 PPM MAX. RESISTANCE CHANGE: $\leq K\Omega$.
2	SHOCK	3 TIMES FREE DROP FROM 75CM HEIGHT TO HARD WOODEN BOARD OF THICKNESS MORE	FREQUENCY CHANGE: ±10PPM MAX. RESISTANCE CHANGE: ≦5 KΩ.
3	LEAKAGE	 PUT CRYSTAL UNITS INTO A HERMETIC CONTAINER AND HELIUM FOR 0.5-0.6. MPA, ND KE P IT FOR 1H; HECK THE LEAKAGE BY A HELIUM LEAK DETECTOR. 	LEAKAGE:1X10 8MBAR.L /S MAX.
4	SOLDERABILIT Y	 (4) DIP THE LEADS INTO FLUX(ROJIN METHANOL)FOR 3~5S. (5) DIP THE LEADS INTO 245±5°C 99% SN DIPPING SOLUTION FOR 5S. 	THE DIPPED PART OF THE LEADS SHOULD HAVE 5% SN COATING
5 н	SOLDERING IEAT RESI STANCE TEST	(3) DIP THE LEADS INTO 260±5°C 99% SN DIPPING SOLUTION FOR 5S.	SHOULD PASS SEALING AND VISUAL TEST. FREQUENCY CHANGE: ±10PPM MAX.
6	LEAK TEST	USE HELIUM LEAK DETECTOR. BOMBING PRESSURE:5KG/CM ² BOMBING TIME: 2 HOURS LEAK SHOULD BE LESS THAN 1E-8 ATM.CC/SEC.	GAS OR AIR SHOULD NOT BE DETECTED.
7 H	IIGH TEMPERATU	SOMEWHERE FOR 500 HOURS AT TEMPERATURE OF 125℃±5℃,THEN KEEP IT FOR 1 TO 2 HOURS UNDER	FREQUENCY CHANGE: ±10PPM MAX. RESISTANCECHANGE: ≦5 KΩ.



NO.	TEST ITEMS	TEST METHOD AND CONDITION	REQUIREMENTS
8	LOW TEMPE	THE CRYSTAL UNITS SHALL BE PUT IN SOMEWHERE FOR 500 HOURS ATTEMPERATURE	FREQUENCY CHANGE: ±10PPM MAX. RESISTANCECHANGE:
	RATUR E ENDU ANCE	OF -40°C,THEN KEEP IT FOR 1 TO 2 HOURS UNDER ROOM.	≦5 KΩ.
9	HUMIDITY ENDURANCE	SOMEWHERE AT 40°C±5°C IN RELATIVE HUMIDITY OF 90%~95% FOR 72 HOURS, THEN KEEP IT FOR ONE OR TWO HOURS UNDER ROOM TEMPERATURE	FREQUENCY CHANGE: ±10PPM MAX. RESISTANCECHANGE: ≦5 KΩ.
10	TEMPERATURE	TEMPERATURE SHIFT FROM LOW(-40°C) TO HIGH(100°C,KEEP 30 MINUTES),SATISFY HIGH(100°C) TO LOW(-40°C,KEEP 30 MINUTES),THEN GO UP TO ROOM TEMPERATURE FOR 10 CYCLES.	FREQUENCY CHANGE: ±10PPM MAX. RESISTANCE CHANGE: ≦5 KΩ.
11	LEAD TENSILTY	 (1) FIX THE UNIT. (2) APPLY 2LB OF WEIGHT AXIS TO THE LESDS. (3) TIME:5S 	SHOULD PASS SEALING AND VISUAL TEST.
12	LEAD	 ATTACH 1LB OF WEIGHT TO EACH OF THE LEADS. BENDING ANGLE:90°C (FROM THE NOMAL POSITION TO 45°COPPOSTTE DIRECTION) BENDING TIME:3S(EACH DIRECTION) NUMBER OF BENDING:2TIMES 	SHOULD PASS SEALING AND VISUAL TEST.
13	MARKING ERASE	SUBMERGE THE UNIT INTO IPA[ISOPROPYL ALCOHOL] SOLUTION FOR 10MINUTES AND BRUSHTHE MARKING 10 TIMES WITH A TOOTH BRUSH.	MARKING SHOULD NOT BE ERASED.



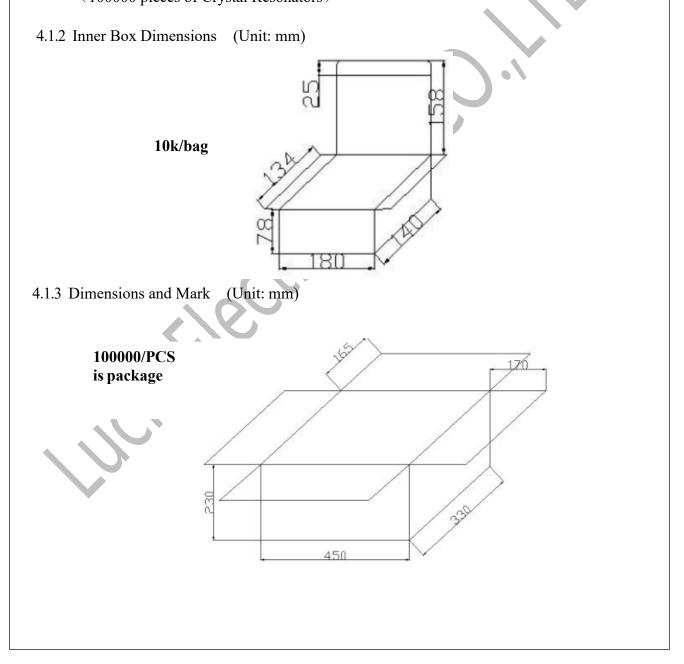
4. PACKING

4.1 Section of package

Package is made of corrugated paper with thickness of 0.8cm.Package has 10 inner boxes, each box has 10 bag

4.1.1 Quantity of package
Per plastic bag 1000 pieces of Crystal Resonators
Per inner box 10 bag (1k/bag)
Per package 10 inner boxes

(100000 pieces of Crystal Resonators)





5. CAUTION

* IN ORDER TO MAINTAIN QUALITY. WITHOUT CHANGE IN CHARACTERISTICS OF THECRYSTAL UNITS.PLEASE FOLLOW BELOW RECOMMENDATION

5.1 SHOCK

5.1.1 ALL CRYSTAL UNITS HAVE A THIN CRYSTAL BLANKS WITHIN IF IT IS DROPPED ABOVE THE ECOMMENDED DROPPING HEIGHT(500mm) THE SPECIFIC HARACTERISTICS AND APPEARANCE CAN BE CHANGED PLEASE PAY SPECIAL ATTENTION TO EXTERNAL SHOCK

5.2. ENVIRONMENTAL

521 CRYSTAL UNITS' FREQUENCY CAN BE CHANGED DUE TO SURROUNOING TEMPERATURE IF IT IS STORED NEXT TO A HIGH TEMPERATURE HETER (ABOVE+85'C) OR BELOW 40'C.AND A STRONG LIGHT SOURCE FOR LONG PERIOD OF TIME. THE ELECTRICAL CHARACTERISTICS CAN BE CHANGED IT IS SUGGESTED THAT THESE ENVIROMENTS BE AVOIDED

522 IF THE UNIT IS PLACED IN A HUMID ENVIRONMENT. LEAD TERMINAL CAN BE DAMAGED: THEREFORE.DO NOT STORE THE CRYSTAL UNITS IN A HUMID ENVIRONMENT

523 CRYSTALUNIT HAS VIBRATING CHARACTERISTICS IF IT IS PLACED WHERE VIBRATION EXISTS THE OPERATING CHARACTERISTICS CAN BE ALTERED; THEREFORE THIS ENVIRONMENT SHOULD BE AVOIDED

5.3 LEADS

53.1 IF THE LEADS ARE BENT 90°FROM ITS AXIS FOR MORE THAN 2 TIMES THE TERMINAL COULD BE DISCONNECTED; THEREFORE DO NOT BENT THE LEADS

532 AFTER SOLDERING CRYSTAL UNITS INTO A PCB IMPACTING THE UNIT FROM THETOP,BOTTOM LEFT OR RIGHT SIDE OF THE UNIT CAN SHATTER THE GLASS PORTION OF THE BASE AENDERING THE UNITUSELESS

5.4 ASSEMBLY METHOD

5.4.1 CORRECT ULTRASONIC FREQUENCY FOR CLEANING SHOULD BE LESS THAN 20KHZ

5.4.2 SOLDERING SHOULD BE BONE USING IEC 61760-1 OR PB-Free Products 5.5 STORAGE

5.5.1 IF THE CRYSTAL UNITS ARE STORED IN HUMID OR SALTY ENVIRONMENT APPEARANCE CAN BE CHANGED AND SOLDERABILITY CAN DETERIORATE; THEREFORE AOID STORING IN SUCH ENVIRONMENT DO NOT STORE THE CRYSTAL UNIT MORE THAN 3 MONTHS



6. Pb-Free PRODUCTS

LK Pb-free program.

The LK Pb-free program is implemented in accordance with European Union (EU) Legislation titled "Restriction of the use of certain Hazardous Substances (RoHS)" including banning the use of Pb in electronic assemblies after July 1, 2006.

LK Definitions

Pb-Free Classification: Component and Assembly Pb content shall be less than 0.1% by weight of the device (in accordance to IPC/EIA J-STD-006) and shall not be intentionally introduced .

Components: LK's definition of components apply to quartz crystal devices Assemblies: LK's definition of assemblies apply to oscillator devices (XO,

VCXO and TCXO's)

Recommended Solder Composition

LK's is following industry trend of using alloy range Sn-

Ag(3.4-4.1)-Cu(0.45-0.9) for reflow and wave soldering.

Pb-free Part Number Identification:

When applicable, the LK specification sheet shall indicate if the device is classified as Pb-free.

Marking and Labeling: LK has a Pb-free labeling method for the packaging of all Pbfree products. The lowest level shipping container shall identify the products as Pbfree.

OTHERS

If you have some doubt or unknowing about this specification, Please contact us for Settlement or development.

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